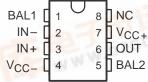
- Low Input Bias Current, 50 pA Typ
- Low Input Noise Current, 0.01 pA/√Hz Typ
- Low Supply Current, 2 mA Typ
- High Input impedance,  $10^{12} \Omega$  Tvp
- Low Total Harmonic Distortion
- Low 1/f Noise Corner, 50 Hz Typ
- Package Options Include Plastic Small-Outline (D) and Standard (P) DIPs

# D OR P PACKAGE (TOP VIEW)



NC - No internal connection

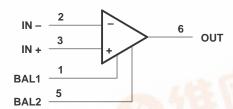
#### description

This device is a low-cost, high-speed, JFET-input operational amplifier with very low input offset voltage and a maximum input offset voltage drift. It requires low supply current, yet maintains a large gain-bandwidth product and a fast slew rate. In addition, the matched high-voltage JFET input provides very low input bias and offset currents.

The LF411 can be used in applications such as high-speed integrators, digital-to-analog converters, sample-and-hold circuits, and many other circuits.

The LF411C is characterized for operation from 0°C to 70°C. The LF411I is characterized for operation from –40°C to 85°C.

#### symbol



#### **AVAILABLE OPTIONS**

411	V a may	PACKAGE			
TA	V <sub>IO</sub> max AT 25°C	SMALL OUTLINE (D)	PLASTIC DIP (P)		
0°C to 70°C	2 mV	LF411CD	LF411CP		
–40°C to 85°C	2 mV	LF411ID	LF411IP		

The D packages are available taped and reeled. Add the suffix R to the device type (i.e., LF411CDR).

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

### LF411 JFET-INPUT OPERATIONAL AMPLIFIER

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC+</sub>	18 V
Supply voltage, V <sub>CC</sub>	
Differential input voltage, V <sub>ID</sub>	$\dots \dots \pm 30 \; V$
Input voltage, V <sub>I</sub> (see Note 1)	$\dots \dots \pm 15 \ V$
Duration of output short circuit	Unlimited
Continuous total power dissipation	500 mW
Package thermal impedance, θ <sub>JA</sub> (see Note 2): D package	197°C/W
P package	104°C/W
Storage temperature range, T <sub>stq</sub>	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

NOTES: 1. Unless otherwise specified, the absolute maximum negative input voltage is equal to the negative power supply voltage.

The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

#### recommended operating conditions

	C SUFFIX		I SUFFIX		UNIT
	MIN	MAX	MIN	MAX	UNIT
Supply voltage, V <sub>CC +</sub>	3.5	18	3.5	18	V
Supply voltage, V <sub>CC</sub> –	-3.5	-18	-3.5	-18	V
Operating free-air temperature, T <sub>A</sub>	0	70	-40	-85	°C

# electrical characteristics over operating free-air temperature range, $V_{CC\pm}$ = $\pm 15\,V$ (unless otherwise specified)

PARAMETER		TEST CONDITIONS		TA		MIN	TVD	MAV	LIMIT
				LF411C	LF411I	IVIIN	TYP	MAX	UNIT
V <sub>IO</sub>	Input offset voltage	$V_{IC} = 0$ ,	$R_S = 10 \text{ k}\Omega$	25°C	25°C		0.8	2	mV
ανιο	Average temperature coefficient of input offset voltage	V <sub>IC</sub> = 0,	$R_S = 10 \text{ k}\Omega$				10	20†	μV/°C
l. a	Input offset current‡	V <sub>IC</sub> = 0	25°C	25°C		25	100	pA	
10			70°C	85°C			2	nA	
IIB	Input bias current‡	\\\\0		25°C	25°C		50	200	pА
		VIC = 0	70°C	85°C			4	nA	
VICR	Common-mode input voltage range					±11	-11.5 to 14.5		٧
VOM	Maximum peak output-voltage swing	R <sub>L</sub> = 10 kΩ				±12	±13.5		V
A. (5)	Large-signal differential voltage	$V_O = \pm 10 \text{ V},  R_L = 2 \text{ k}\Omega$	Pt = 2 kO	25°C	25°C	25	200		V/mV
AVD			0°C to 70°C	-40°C to 85°C	15	200		V/IIIV	
rį	Input resistance	T <sub>J</sub> = 25°C					1012		Ω
CMR R	Common-mode rejection ratio	$R_S \le 10 \text{ k}\Omega$				70	100		dB
ksvr	Supply-voltage rejection ratio	See Note 3				70	100		dB
ICC	Supply current						2	3.4	mA

 $<sup>\</sup>overline{\dagger}$  At least 90% of the devices meet this limit for  $\alpha_{VIO}$ .

NOTE 3: Supply-voltage rejection ratio is measured for both supply magnitudes increasing or decreasing simultaneously.



<sup>‡</sup> Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive. Pulse techniques must be used that will maintain the junction temperatures as close to the ambient temperature as possible.

## LF411 JFET-INPUT OPERATIONAL AMPLIFIER

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# operating characteristics, $V_{CC\pm}$ = $\pm 15$ V, $T_A$ = $25^{\circ}C$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR	Slew rate		8	13		V/μs
В1	Unity-gain bandwidth		2.7	3		MHz
٧n	Equivalent input noise voltage	$f = 1 \text{ kHz},  R_S = 20 \Omega$		18		nV/√ <del>Hz</del>
In	Equivalent input noise current	f = 1 kHz		0.01		pA/√ <del>Hz</del>

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